

Maximum Ratings

Symbol	Conditions	Values	Units
V_{CEVsus}	$I_C = 1 \text{ A}$, $V_{BE} = -2 \text{ V}$	1000	V
V_{CEV}	$V_{BE} = -2 \text{ V}$	1000	V
V_{CBO}	$I_E = 0$	1000	V
V_{EBO}	$I_C = 0$	7	V
I_C	D. C.	30	A
I_{CM}	$t_p = 1 \text{ ms}$	60	A
$I_F = -I_C$	D. C.	30	A
I_B		2	A
P_{TOT}	$T_{case} = 25 \text{ }^\circ\text{C}$, per darlington	310	W
T_{vj}		-40 ... +150	$^\circ\text{C}$
T_{stg}		-40 ... +125	$^\circ\text{C}$
V_{isol}	a. c. 50 Hz, r. m. s.	2500~	V

Thermal Characteristics

R_{thjc}	per darlington/per module	0,4/0,2	$^\circ\text{C/W}$
R_{thjc}	per diode/per module	1,5/0,75	$^\circ\text{C/W}$
R_{thch}	per 1/2 module/per module	0,15/0,075	$^\circ\text{C/W}$

Electrical Characteristics¹⁾

		min.	typ.	max.	
I_{CEV}	$V_{CE} = V_{CEV}$, $V_{BE} = -2 \text{ V}$			1	mA
I_{EBO}	$I_C = 0$, $V_{BE} = -7 \text{ V}$			200	mA
$V_{CEsat}^{2)}$	$I_C = 30 \text{ A}$, $I_B = 0,6 \text{ A}$			2,5	V
$V_{BEsat}^{2)}$	$I_C = 30 \text{ A}$, $I_B = 0,6 \text{ A}$			3,5	V
$h_{21E}^{2)}$	$I_C = 30 \text{ A}$	$V_{CE} = 2,8 \text{ V}$	75		
		$V_{CE} = 5 \text{ V}$	100		

Switching Characteristics for Resistive Load¹⁾

t_{on}	$I_C = 30 \text{ A}$ $I_{B1} = -I_{B2} = 0,6 \text{ A}$ $V_{CC} = 600 \text{ V}$		0,7	2,5	μs
t_s			11	15	μs
t_f			1,2	3,0	μs

Inverse Diode Characteristics¹⁾

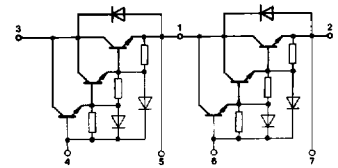
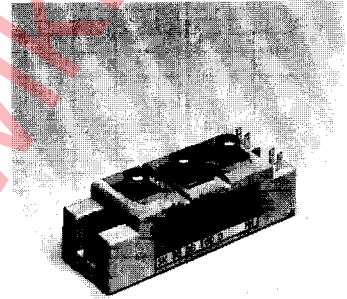
$V_F = -V_{CE}$	$I_F = -I_C = 30 \text{ A}$		1,8	V
$I_{FSM} = -I_{Cp}$	$\sin 180^\circ$, 10 ms	300		A
I_{RM}	$I_F = -I_C = 30 \text{ A}$, $-di_F/dt = 100 \text{ A}/\mu\text{s}$ $V_{BE} = -3 \text{ V}$, $V_R = V_{CE} = 400 \text{ V}$, $T_{vj} = 125 \text{ }^\circ\text{C}$		30	A
Q_{rr}			15	μC

Mechanical Data

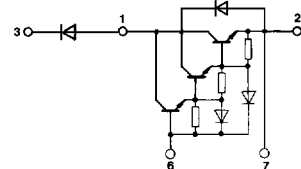
M_1	Case to heatsink	SI units	3	6	Nm
		US units	27	53	lb. in.
M_2	Busbars to terminals	SI units	2,5	5	Nm
		US units	22	44	lb. in.
w			250		g
Case		DB	D 11		
		DAL	D 21		

SEMITRANS® 2 NPN Power Darlington Modules 30 A, 1000 V

SK 30 DB 100 D
SK 30 DAL 100 D



DB



DAL

Features

- Isolated baseplate (ease of mounting of one or several modules on one heatsink)
- All electrical connections on top (ease of interconnecting of modules with busbars/PCB)
- Large clearances and creepage distances
- Parallel connected fast recovery inverse diode
- UL recognized, file no. 63 532

Typical Applications

- Switched mode power supplies
- DC servo and robot drives
- AC motor controls
- Brake choppers (DAL)

¹⁾ $T_{case} = 25 \text{ }^\circ\text{C}$ unless otherwise stated

²⁾ $t_p \leq 300 \mu\text{s}$, $D \leq 1,5 \%$

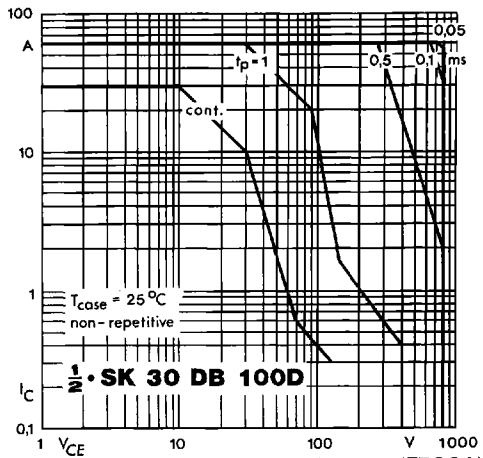


Fig. 1 Forward biased safe operating area (FBSOA)

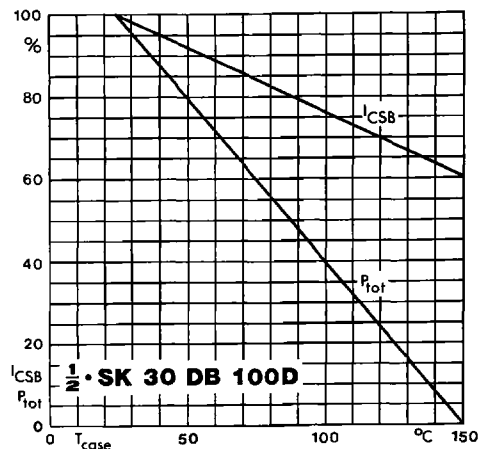


Fig. 2 Shifting the limits of the FBSOA with temperature

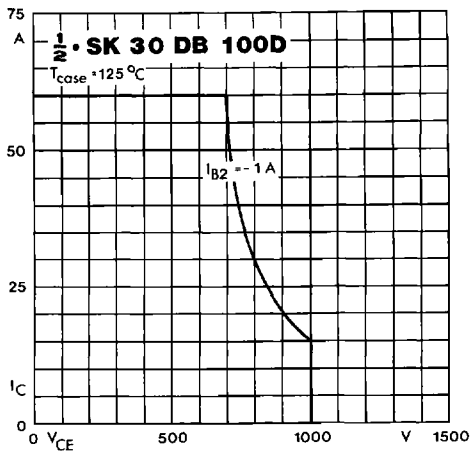


Fig. 3 Reverse biased safe operating area (RBSOA)

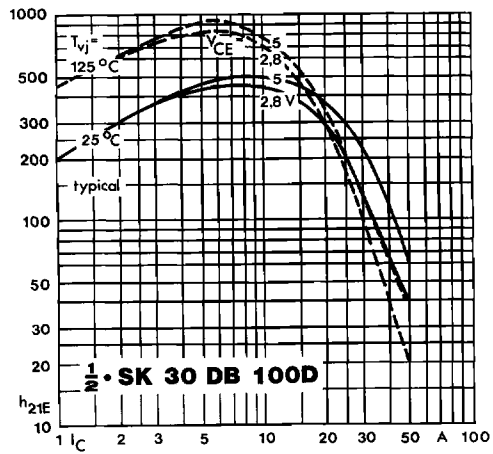


Fig. 4 Forward current transfer ratio vs. coll. current

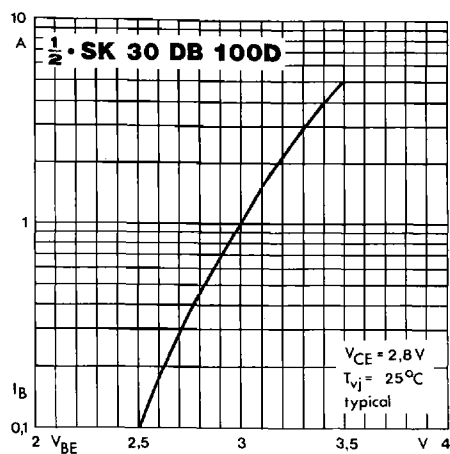


Fig. 5 Base current/voltage characteristic

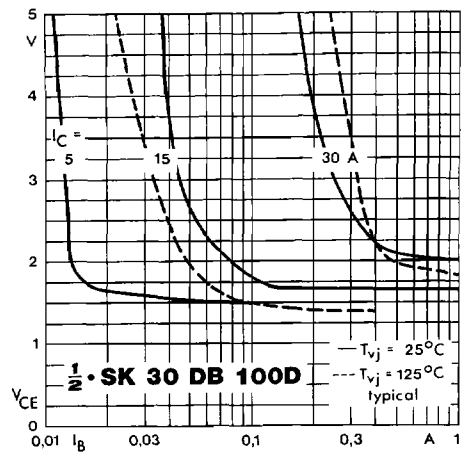


Fig. 6 Collector-emitter voltage vs. base current

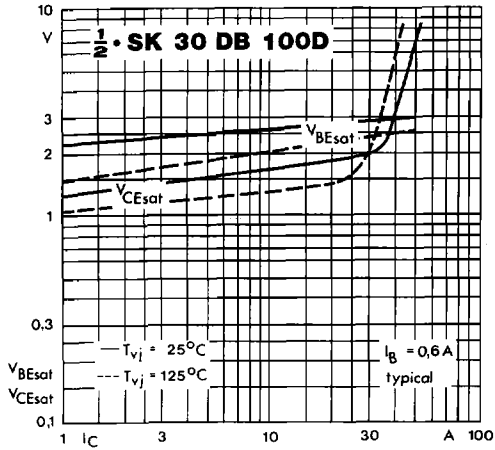


Fig. 7 Saturation voltages vs. collector current

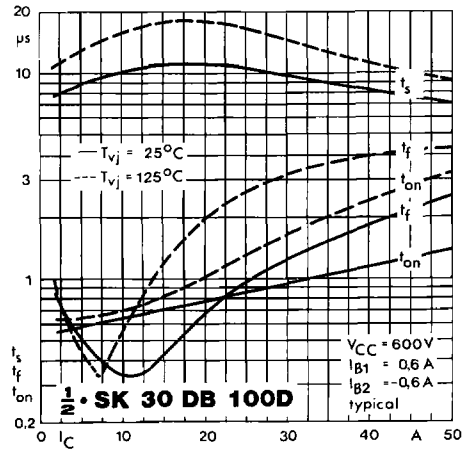


Fig. 8 Switching times vs. collector current

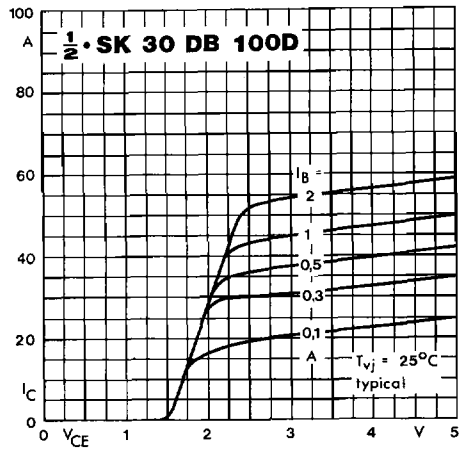


Fig. 9 Collector current/voltage characteristics

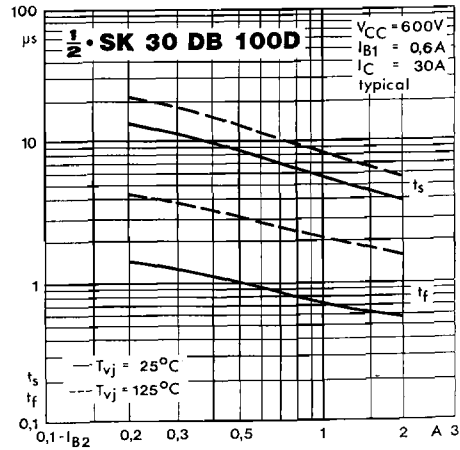


Fig. 10 Turn-off times vs. negative base current

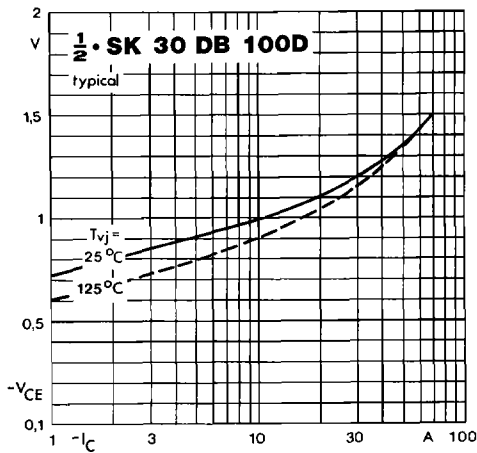


Fig. 11 Inverse diode forward characteristics

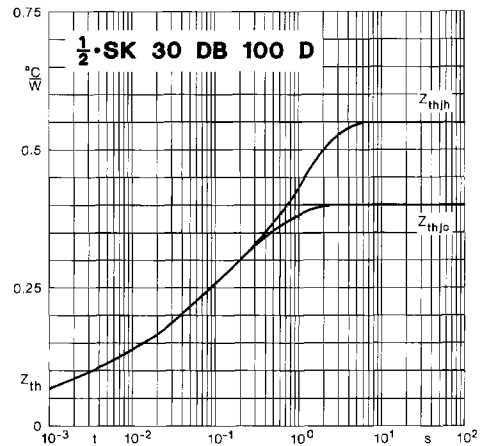


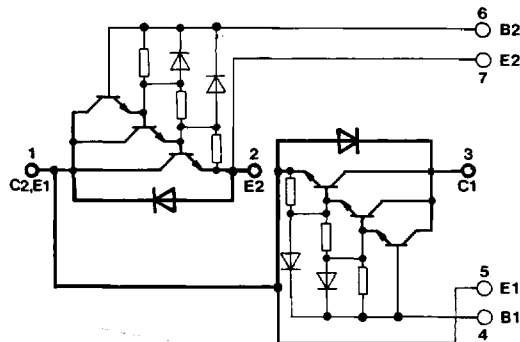
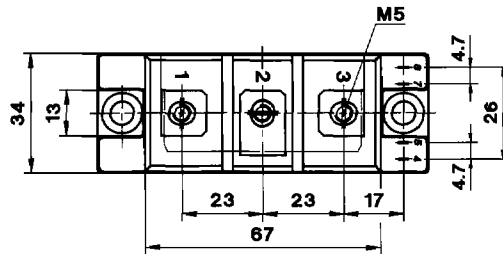
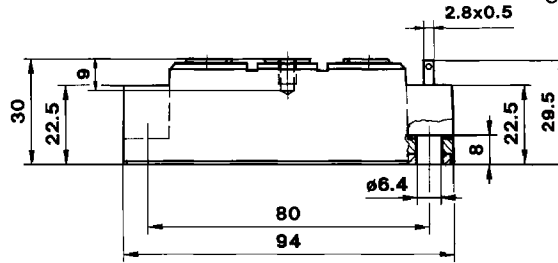
Fig. 12 Transient thermal impedance vs. time

SK 30 DB 100 D

Case D 11

SEMITRANS® 2

UL recognized, file no. 63 532



Dimensions in mm

SK 30 DAL 100 D

Case D 21

SEMITRANS® 2

UL recognized, file no. 63 532

